ESD SMD Comm X7R, Ceramic, 4700 pF, 10\%, 25 VDC, X7R, SMD, MLCC, Temperature Stable, Electro Static Discharge, Class II, 0603

| General Information |  |
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| Series | ESD SMD Comm X7R |
| Style | SMD Chip |
| Description | SMD, MLCC, Temperature Stable, Electro <br> Static Discharge, Class II |
| Features | Temperature Stable, Class II |
| RoHS | Yes |
| Termination | Tin |
| Marking | No |
| AEC-Q200 | No |
| Typical Component | 4.8 mg |
| Weight | 78 Weeks |
| Shelf Life | 1 |
| MSL |  |


| Specifications |  |
| :--- | :--- |
| Capacitance | 1700 pF |
| Measurement Condition | $10 \%$ |
| Capacitance Tolerance | 25 VDC |
| Voltage DC | $16,000 \mathrm{~V} \mathrm{ESD}$ Level |
| ESD Level per AEC-Q200 | 62.5 VDC |
| Dielectric Withstanding Voltage | $-55 /+125^{\circ} \mathrm{C}$ |
| Temperature Range | X 7 R |
| Temperature Coefficient | $15 \%, 1 \mathrm{kHz} 1.0 \mathrm{Vrms}$ |
| Capacitance Change with Reference | $3.5 \% 1 \mathrm{kHz} 1.0 \mathrm{Vrms}$ |
| to +25 ${ }^{\circ} \mathrm{C}$ and O VDC Applied (TCC) | $3 \%$ Loss/Decade Hour: |
| Dissipation Factor | Referee Time is 1000 Hours |
| Aging Rate | 100 GOhms |
| Insulation Resistance |  |

